BRIGHTEK

BRIGHTEK (EUROPE) LIMITED

Brighten Up The World With LED!

ISO/TS 16949:2009 BS EN ISO 14001:2004 QC 080000 IECQ HSPM

PRODUCT DATASHEET

ATTENTION
OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES

- ▶ PCB Side View
- ▶ 1204 Series
- ▶ Green (525nm)

Release Date: 13 November 2015 Version: A1.2

N0G02S77SV

Side View
1204 Series

Side View 1204

RoHS Compliant

FEATURES:

- **Package:** Side View PCB SMT Package
- **Forward Current:** 20mA
- **Forward Voltage (typ.):** 3.2V
- **Luminous Intensity (typ.):** 500mcd @20mA
- **Colour:** Green
- **Wavelength:** 525nm
- **Viewing angle:** 120°
- **Materials:**
  - Die: InGaN
  - Resin: Epoxy (Water Clear)
- **Operating Temperature:** -20~+80°C
- **Storage Temperature:** -30~+100°C
- **ESD:** 500V
- **Grouping parameters:**
  - Forward voltage
  - Luminous intensity
  - Dominant Wavelength
- **Soldering methods:** Reflow
- **Preconditioning:** acc. to JEDEC Level 3
- **Packing:** 8mm tape with 3000/reel, ø180mm (7'')

APPLICATIONS:

- Backlighting
- Indication Light
- Side view light strip
- Switch light
- Dashboard
- Keyboard

CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I_F	30	mA
Peak Forward Current Duty 1/10@10KHz	I_{FP}	100	mA
Reverse Current @5V	I_R	50	μA
Power Dissipation	PD	108	mW
Electrostatic Discharge	ESD	500	V
Operating Temperature	T_{OPR}	-20~+80	°C
Storage Temperature	T_{STG}	-30~+100	°C

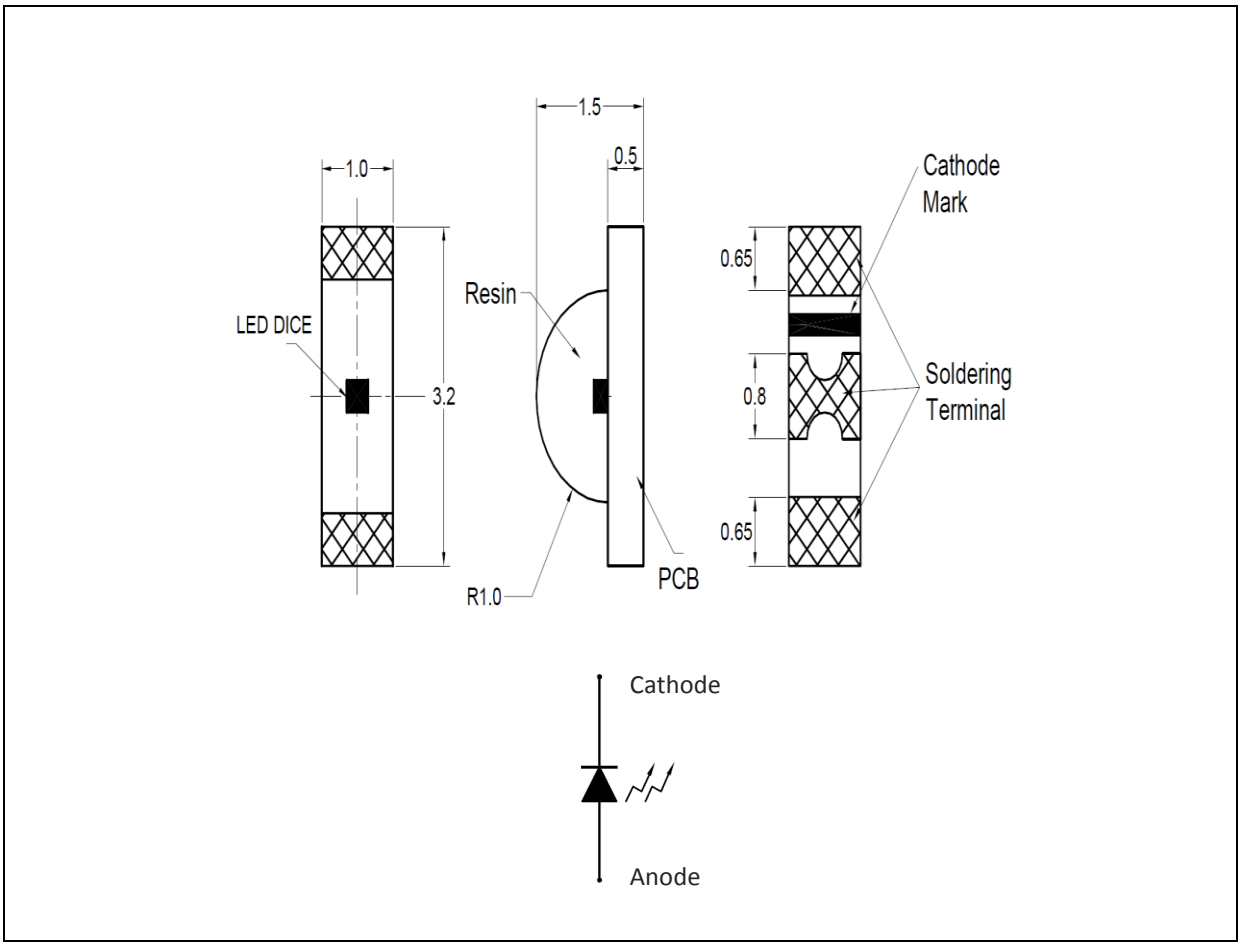
Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test Condition
		Min.	Typ.	Max.		
Forward Voltage	V_F	2.8	---	3.6	V	I_F=20mA
Luminous Intensity	I_V	200	500	---	mcd	I_F=20mA
Dominant Wavelength	λ_D	---	525	---	nm	I_F=20mA
Spectral Line Half Bandwidth	$\Delta\lambda$	---	36	---	nm	I_F=20mA
Viewing Angle	$2\theta_{1/2}$	---	120	---	deg	I_F=20mA

1. Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V
2.

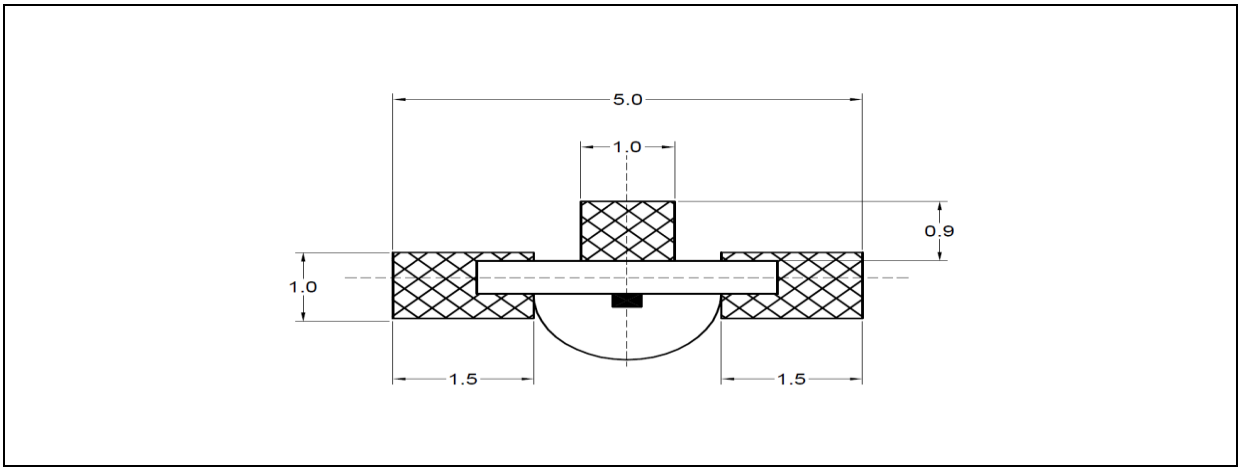
OUTLINE DIMENSION:

Package Dimension:



1. All dimensions are in millimetre (mm).
2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).
2. Tolerance ±0.1mm with angle tolerance ±0.5°.

BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
1	2.8	3.0	V
2	3.0	3.2	
3	3.2	3.4	
4	3.4	3.6	

Luminous Intensity Classifications (I_F = 20mA):

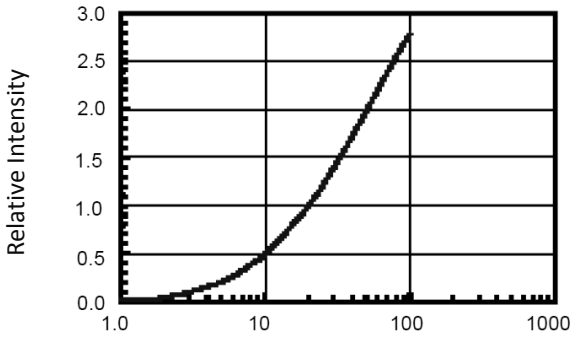
Code	Min.	Max.	Unit
S	200	320	mcd
T	320	500	
U	500	800	
V	800	1250	

Dominant Wavelength Classifications (I_F = 20mA):

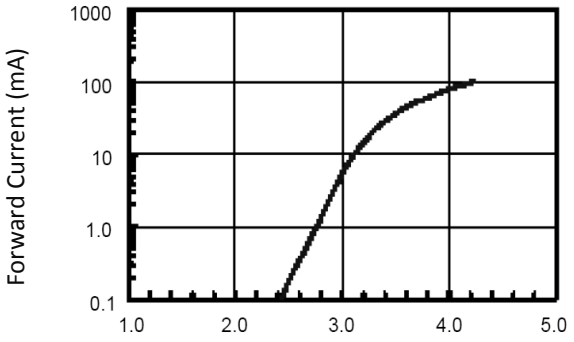
Code	Min.	Max.	Unit
1O	519	522	nm
1P	522	525	
1Q	525	528	
1R	528	531	
1S	531	534	

ELECTRO-OPTICAL CHARACTERISTICS:

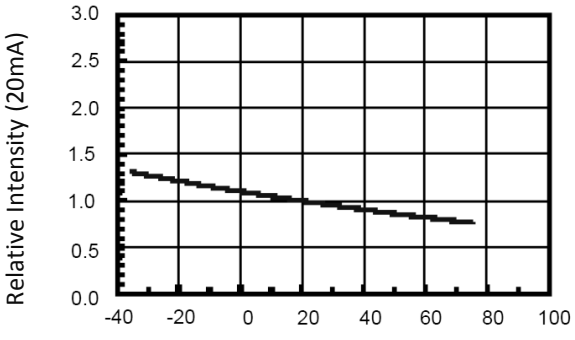
Relative Intensity v.s. Forward Current



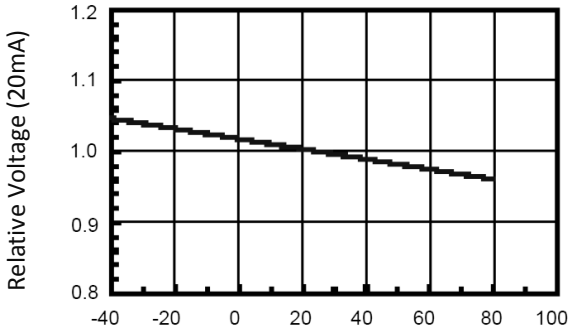
Forward Current v.s. Forward Voltage



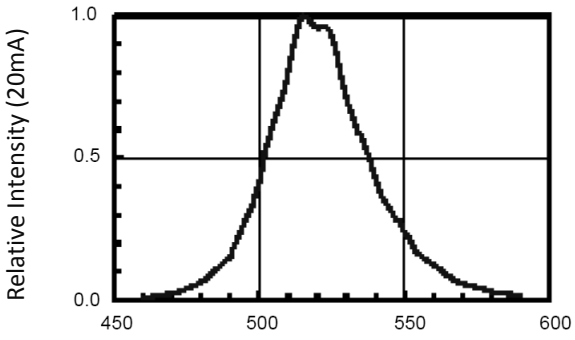
Relative Intensity v.s. Temperature



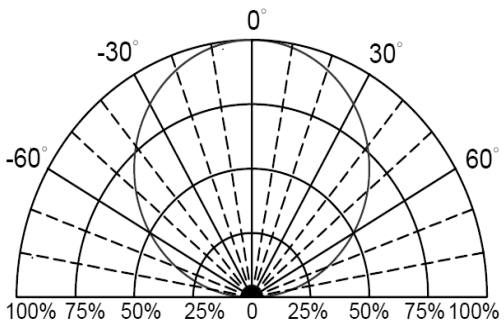
Relative Forward Voltage v.s. Temperature



Relative Intensity v.s. Wavelength

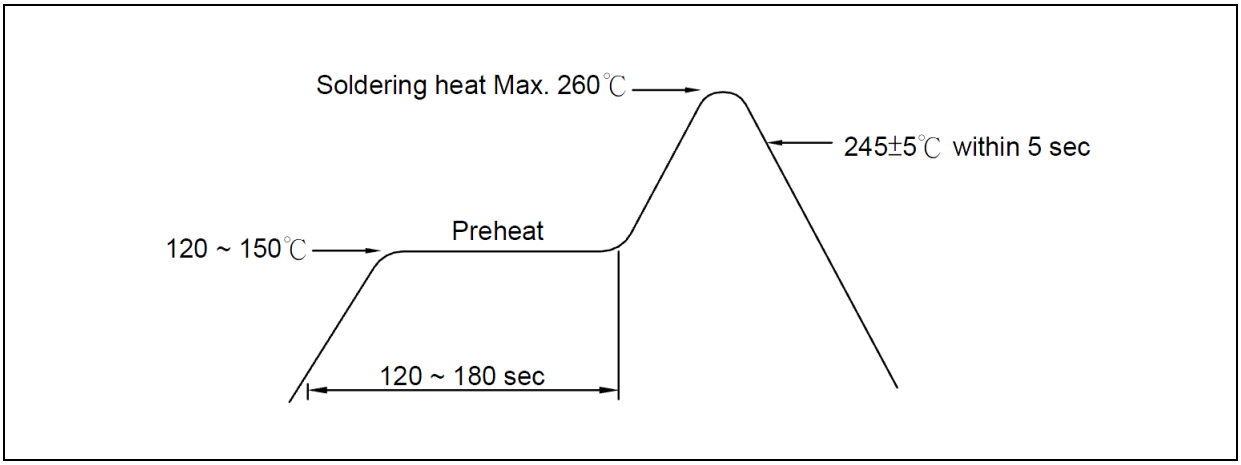


Directive Radiation

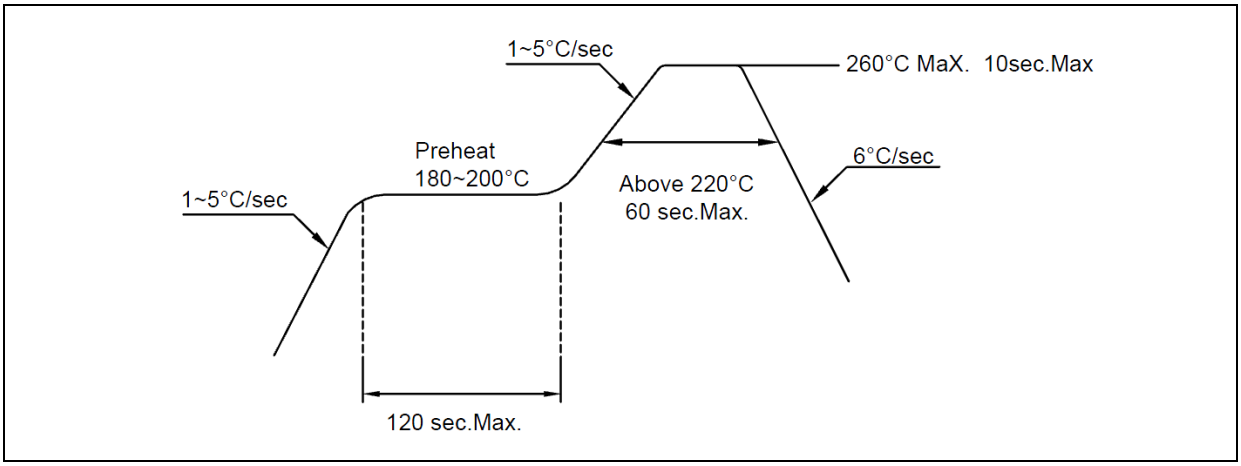


RECOMMENDED SOLDERING PROFILE:

Wave Solder:



Lead-free Solder:



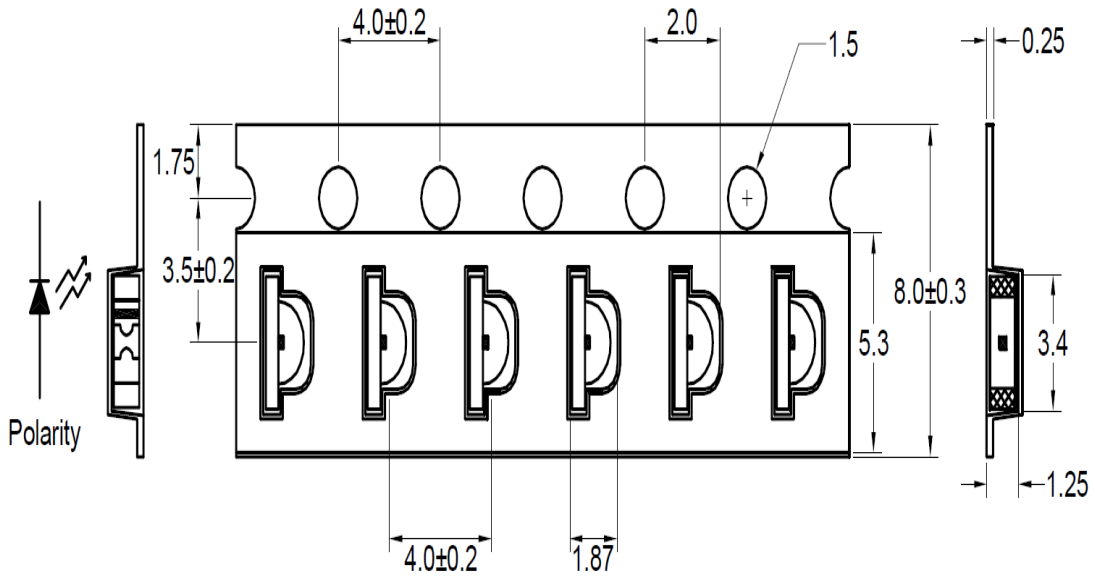
Note:

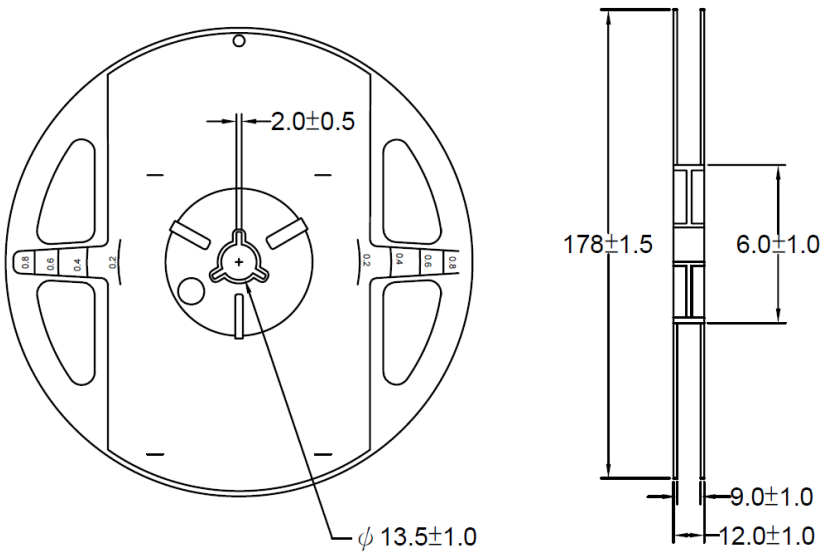
1. Maximum reflow soldering: 2 times.
2. Before, during, and after soldering, should not apply stress on the components and PCB board.

PACKING SPECIFICATION:

Reel Dimension:

3000pcs/reel





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

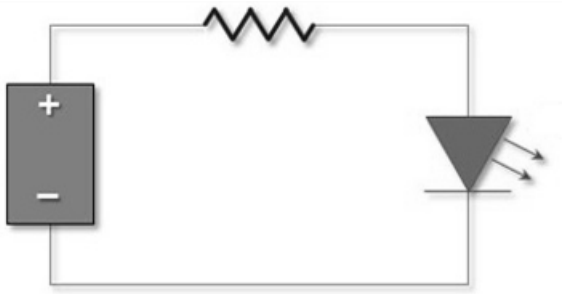
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

REVISION RECORD:

Version	Date	Summary of Revision
A1.0	20/12/2013	Datasheet set-up.
A1.1	17/10/2014	Update series name.
A1.2	13/11/2015	Part number adds -SV for side view.